

Abstract:

The present invention relates to a conveyance device with which a subject to be molded can be positioned relative to a forming die. This conveyance device 13 conveys a subject to be molded W1 to one die 2 from among forming dies 2, 3 to which a resin material J is supplied from a resin injection part 14 and comprises: a retaining unit 20 which retains and delivers the subject to be molded W1 to the one die 2; a first movement mechanism 21 which moves the subject to be molded W1 having been delivered to the one die 2 in a first direction toward the resin injection part 14; and a second movement mechanism 22 which moves the subject to be molded W1 having been delivered to the one die 2 in a second direction differing from the first direction.

FIGURE 12